SIC MOSFET RELAY AA53

TOWARD RELAYS

AA53 SERIES

3300V Sic mosfet relay

MGT **A** Manufacturer Group of Technology

SILICON CARBIDE SiC MOSFET RELAY ▲ DIP and SMD type High voltage with low on-resistance Fast reverse recovery time High avalanche ruggedness Moisture Sensitivity Level ▲ MSL 1 W UL 1577 approved ▲ File no E344988

SPECIFICATION

Item		Characteristics
Contact Form		1 Form A 🔺 Normally open switch
Load Voltage	VL	3300V
Operation LED Current	I _{F ON}	5.0mA
Load Current	l _L	350mA
On-Resistance	R _{ON}	3.2Ω
Output Capacitance	Соит	220pF
Low Off-State Leakage Current	I _{LEAK}	1µA at 3300V _{DC}

APPLICATIONS

Battery	Building	Electric	Energy	EV	Industrial	Measurement
Management	Automation	Mobility	Management	Charging	Automation	Equipment
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DIMENSIONS

Package		Dimensions	PCB Board Pattern
DIP6-5	8.8 ±0.3 1.2 ±0.2 		5-Ø0.8 5-Ø0.8
SMD6-5	8.8 ±0.3 1.2 ±0.2 0.5 ± ±0.1 0.5 ± ±0.2 0.5	15° max.	TOP VIEW

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TOWARD RELAYS

PIN DESCRIPTION AND PART NUMBER

Circuit Diagram	Pin Description	Part No.	Package	Packing
	1: Anode (+) • LED 2: Cathode (-) • LED 3: NC 4: Drain • MOSFET 1 6: Drain • MOSFET 2	AA53 AA53F AA53F-R1	DIP6-5 SMD6-5 SMD6-5	Tube (50pcs) Tube (50pcs) Reel (1000pcs)

ABSOLUTE MAXIMUM RATINGS A AMBIENT TEMPERATURE T_A = 25°C

	Item	Condition	Symbol	Value	Unit
	Continuous LED Current		I _F	50	mA
	Peak LED Current	100 Hz, Duty 1%	I _{FP}	500	mA
Input	LED Reverse Voltage		V _R	5	V
	Input Power Dissipation		P _{IN}	75	mW
	Load Voltage		VL	3300	V (AC peak or DC)
• • • •	Load Current		IL.	350	mA
Output	Peak Load Current	10 ms, 1 shot	I _{PEAK}	1050	mA
	Output Power Dissipation		P _{OUT}	550	mW
	Total Power Dissipation		P _T	600	mW
	I/O Breakdown Voltage		V _{I/O}	3750	Vrms
Relay	I/O Breakdown Voltage (Suffix-H)		V _{I/O}	5000	Vrms
	Operating Temperature Range		T _{OPR}	-40 to +85	°C
	Storage Temperature Range		T _{STG}	-40 to +100	°C

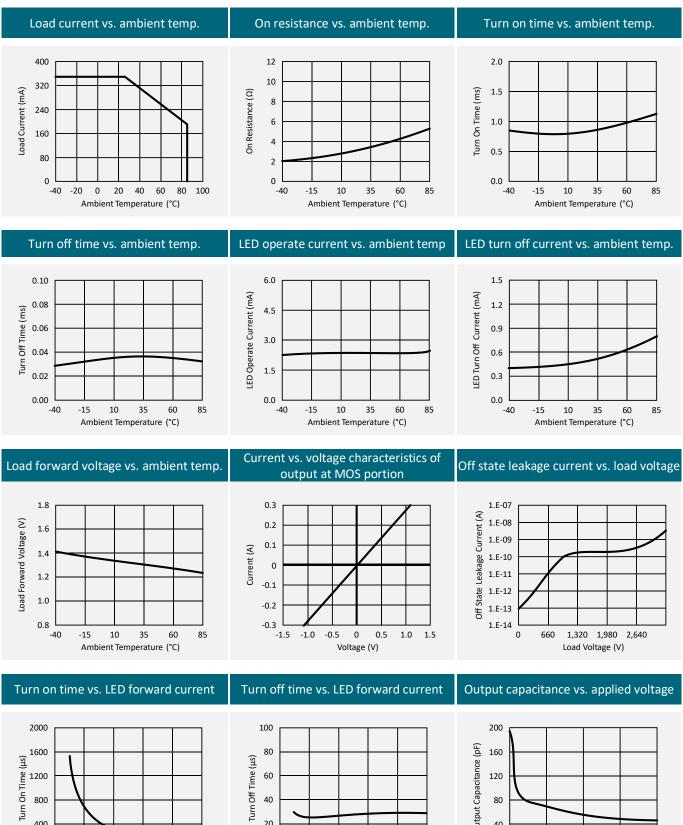
ELECTRICAL CHARACTERISTICS AMBIENT TEMPERATURE T_A = 25°C

	Item	Condition	Symbol	Min.	Тур.	Max.	Unit
	LED Forward Voltage	I _F = 10mA	VF	1	1.33	1.5	V
Input	Operation LED Current		I _{F ON}		2.4	5	mA
	Recovery LED Voltage		V _{F OFF}	0.5	1.2		V
	On-Resistance Drain to Drain (tested within 1 sec.)	I _F =10mA, I _L =Rating	R _{ON}		3.2	4	Ω
Output	Off-State Leakage Current	V _L =3300V	I _{LEAK}			1	μΑ
	Output Capacitance	V _L =0V, f=1 MHz	C _{OUT}		220		рF
Trans-	Turn-On Time	I_F =10mA, I_L =Rating	Ton		1	3	ms
mission	Turn-Off Time	I_F =10mA, I_L =Rating	T _{OFF}		0.05	1	ms
Coupled	I/O Insulation Resistance		R _{I/O}	10 ¹⁰			Ω
Coupled	I/O Capacitance	f=1MHz	C _{I/O}		1.3		рF

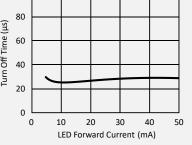


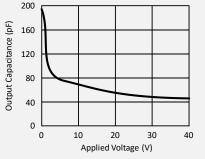
TOWARD RELAYS

REFERENCE DATA









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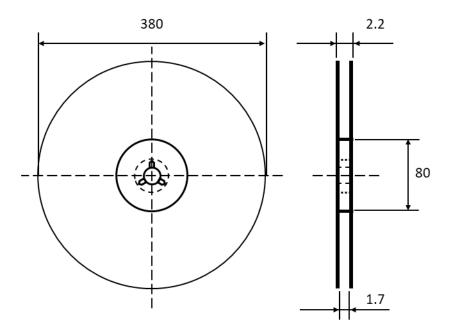
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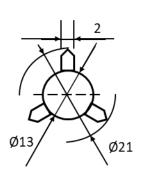


TOWARD RELAYS

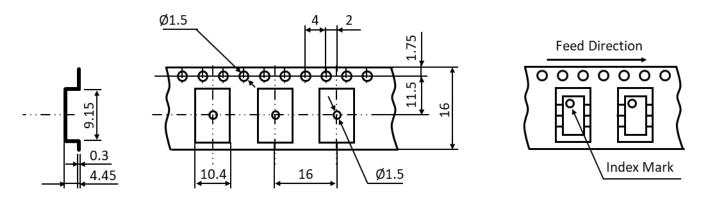


REEL DIMENSIONS All dimensions in mm





TAPE DIMENSIONS All dimensions in mm



Tape and Reel Packing	PCS/Reel
SMD 6-5	1000

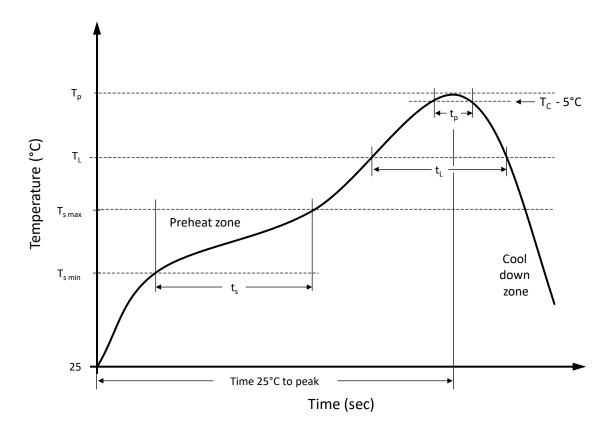
Tube Packing	PCS/Tube	Tubes/Box	Units/Box
SMD 6-5	50	30	1500
DIP 6-5	50	30	1500

STORAGE AND HANDLING CONDITIONS

ESD level	Floor life	Conditions	MSL
HBM class 2	Unlimited	T _A < 30°C, RH < 85%	1



RECOMMENDED REFLOW SOLDERING PROFILE A SMD PACKAGE



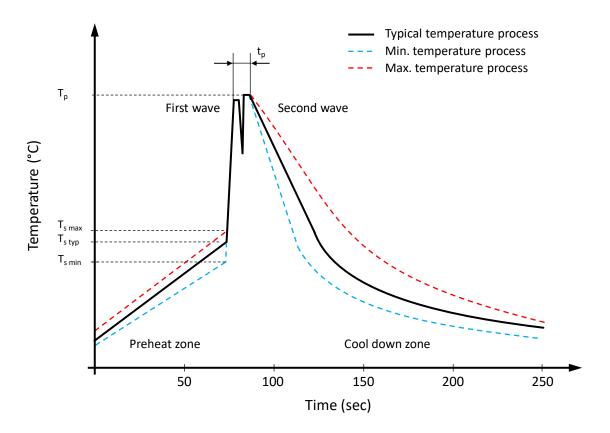
Recommended reflow soldering conditions ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	T_{smin}	100 °C	150 °C
Preheat temperature max.	T_{smax}	150 °C	200 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	120 seconds	120 seconds
Ramp-up rate (T_L to T_p)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	ΤL	183 °C	217 °C
Time t_L maintained above T_L	tL	150 seconds max.	60 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	t _p	20 seconds max.	30 seconds max.
Ramp-down rate (T_L to T_p)		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes

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RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE



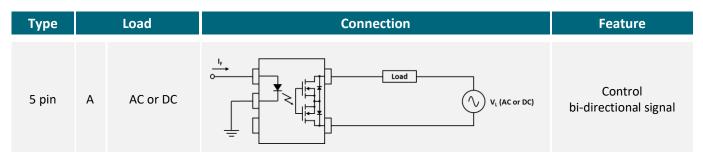
Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value • Sn-Pb Assembly	Value • Pb-free Assembly
Preheat temperature min.	T_{smin}	100 °C	100 °C
Preheat temperature typical	T _{s typ}	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t _p	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



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LOAD CONNECTING METHOD

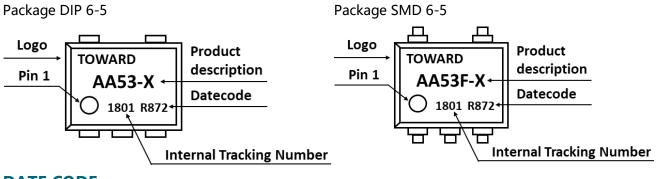


PRODUCT CODE

Example: AA53 series ▲ 3300V ▲ SMD6-5 ▲ Tape & Reel

A	A	5	3	-		F		R1	
Рас	kage	Ser	Series Special Suffix		Special Suffix		Туре		king
AA AM	6-5 8-6	50 51 52 53 54 58	650V 1200V 1700V 3300V 6600V 1800V	Blank A H	Standard Low Leakage Current High Insulation	Blank F S	DIP SMD SOP	Blank R1	Tube Reel

PRODUCT MARKING



DATE CODE

Example: R872

	R	8	8		7		2
Material Characteristics		Year		Month		Week of the Month	
R H	RoHS compliant Halogen free	8 9 A B C G	2018 2019 2020 2021 2022 2022	1 2 3 4 5 12	Jan Feb Mar Apr May Dec	1 2 3 4	1 st 2 nd 3 rd 4 th

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RELIABILITY TESTS A STANDARD

Standard: JESD22-A

No.	Test	Test	Test	Test
NO.		Specification	Standard	Limits
1	Moisture Sensitivity Level Test	Bake condition: Temperature: 125°C; Duration 24 hours Soak condition: Temperature: 30°C; Humidity: 60% RH Duration 192 hours Reflow condition: Peak temperature: 260°C Duration: 3 cycles	JESD22-A113H	No abnormal phenome- non was found. Functional test passed.
2	High Temperature Storage Test	Temperature: 150°C Duration: 500 hours	JESD22-A103E	No abnormal phenome- non was found. Functional test passed.
3	Temperature Cycling Test	Temperature range: -55°C to +125°C -55°C for 30 minutes +125°C for 30 minutes Duration: 100 cycles with 1 cycle = 70 minutes	JESD22-A104E	No abnormal phenome- non was found. Functional test passed.
4	Low Temperature Storage Test	Temperature: -40°C Duration: 500 hours	JESD22-A119E	No abnormal phenome- non was found. Functional test passed.
5	Temperature & Humidity Storage Test	Temperature: 85°C Humidity: 85% RH Duration: 500 hours	JESD22-A101D	No abnormal phenome- non was found. Functional test passed.
6	Highly Accelerated Temperature and Humidity Stress Test	Temperature: 130°C Humidity: 85% RH Duration: 96 hours	JESD22-A118B	No abnormal phenome- non was found. Functional test passed.



REVISION TABLE

Revision	Date	Status	Notes
001	01/10/2021	Initial release	Initial publication

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